

1.27-Socket Kit for Stamp-S3

SKU:A138



Description

The **1.27-Socket Kit for Stamp-S3** is a surface-mount socket kit designed for the Stamp-S3, with a pitch of 1.27mm. Users can integrate it into their PCB designs to meet various embedded requirements and expand functionality.

Features

- Surface-mount socket @ 17Pin/11Pin
- 1.27mm pitch

Includes

- 10 x Surface-mount sockets (1.27mm-17Pin)
- 10 x Surface-mount sockets (1.27mm-11Pin)

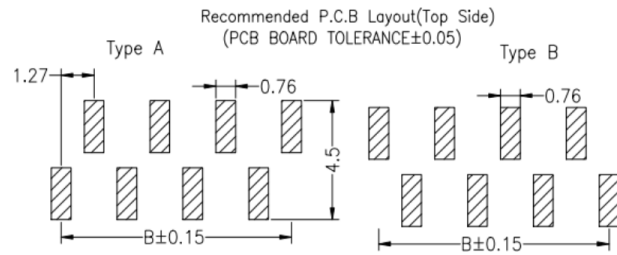
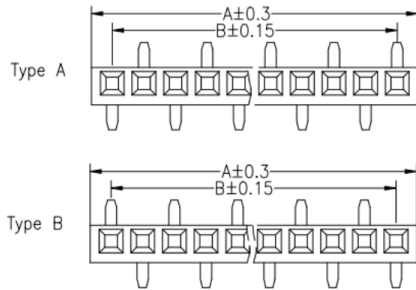
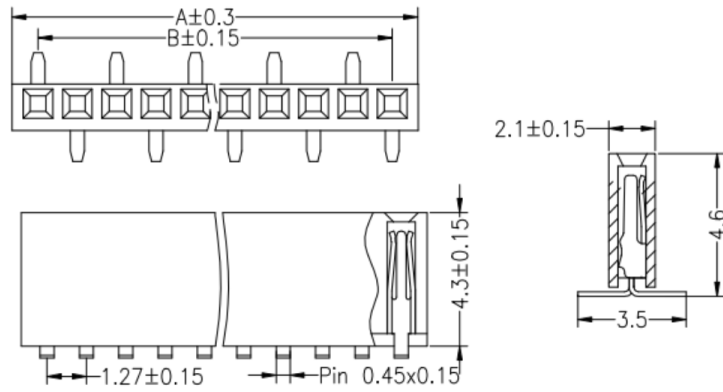
Applications

- PCB DIY

Specifications

Specification	Details
Operating Temperature	-40°C to 105°C
Soldering Temperature	230°C (30-60 seconds) / 260°C (10 seconds)
Socket Type	17Pin/11Pin
Socket Height	4.6mm
Pitch	1.27mm
Net Weight	0.4g (17p) / 0.1g (11p)
Product Size	22 x 4.6 x 3.5mm (For 17P), 14 x 4.6 x 3.5mm (For 11P)
Package Size	136 x 92 x 13mm
Product Weight	6.7g
Gross Weight	8.7g

Model Size



UNIT :MM